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DATASHEET

4 PIN DIP PHOTOTRANSISTOR PHOTOCOUPLER EL817 Series



Features:

- Current transfer ratio
- (CTR: 50~600% at IF = 5mA, VCE = 5V)
- High isolation voltage between input
- and output (Viso = 5000Vrms)
- Creepage distance > 7.62mm
- Operating temperature up to +110°C
- · Compact small outline package
- •The product itself will remain within RoHS compliant version
- Compliance with EU REACH
- UL and cUL approved(No.E214129)
- VDE approved (No. 132249)
- SEMKO approved
- NEMKO approved
- DEMKO approved
- FIMKO approved
- CQC approved

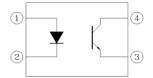
Description

The EL817series of devices each consist of an infrared emitting diodes, optically coupled to a phototransistor detector. They are packaged in a 4-pin DIP package and available in wide-lead spacing and SMD option.

Applications

- Programmable controllers
- System appliances, measuring instruments
- Telecommunication equipments
- Home appliances, such as fan heaters, etc.
- Signal transmission between circuits of different potentials and impedances

Schematic



Pin Configuration

- 1. Anode 2. Cathode
- 3. Emitter
- 4. Collector

Absolute Maximum Ratings (Ta=25°C)

	Parameter	Symbol	Rating	Unit
	Forward current	I _F	60	mA
	Peak forward current (1us, pulse)	I _{FP}	1	А
Input	Reverse voltage	V _R	6	V
	Power dissipation	D	100	mW
	Derating factor (above $T_a = 100^{\circ}C$)	P _D	2.9	mW/°C
	Power dissipation		150	mW
	Derating factor (above $T_a = 100^{\circ}C$)	P _C	5.8	mW/°C
Output	Collector current	I _C	50	mA
	Collector-Emitter voltage	V _{CEO}	35	V
	Emitter-Collector voltage	V _{ECO}	6	V
Total Powe	Total Power Dissipation		200	mW
Isolation Voltage*1		V _{ISO}	5000	V rms
Operating Temperature		T _{OPR}	-55 to 110	°C
Storage Temperature		T _{STG}	-55 to 125	°C
Soldering Temperature* ²		T _{SOL}	260	°C

Notes:

*1 AC for 1 minute, R.H.= 40 ~ 60% R.H. In this test, pins 1, 2 are shorted together, and pins 3, 4 are shorted together. *2 For 10 seconds

Electro-Optical Characteristics (Ta=25°C unless specified otherwise)

Input						
Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Forward Voltage	V _F	-	1.2	1.4	V	I _F = 20mA
Reverse Current	I _R	-	-	10	μA	$V_R = 4V$
Input capacitance	C _{in}	-	30	250	pF	V = 0, f = 1kHz
Output						
Parameter	Symbol	Min	Тур.	Max.	Unit	Condition
Collector-Emitter dark current	I _{CEO}	-	-	100	nA	$V_{CE} = 20V, I_F = 0mA$
Collector-Emitter breakdown voltage	BV _{CEO}	35	-	-	V	I _C = 0.1mA
Emitter-Collector breakdown voltage	BV _{ECO}	6	-	-	V	I _E = 0.1mA
Transfer Characteristics						
Parameter	Symbol	Min	Тур.	Max.	Unit	Condition
EL817		50	-	600		

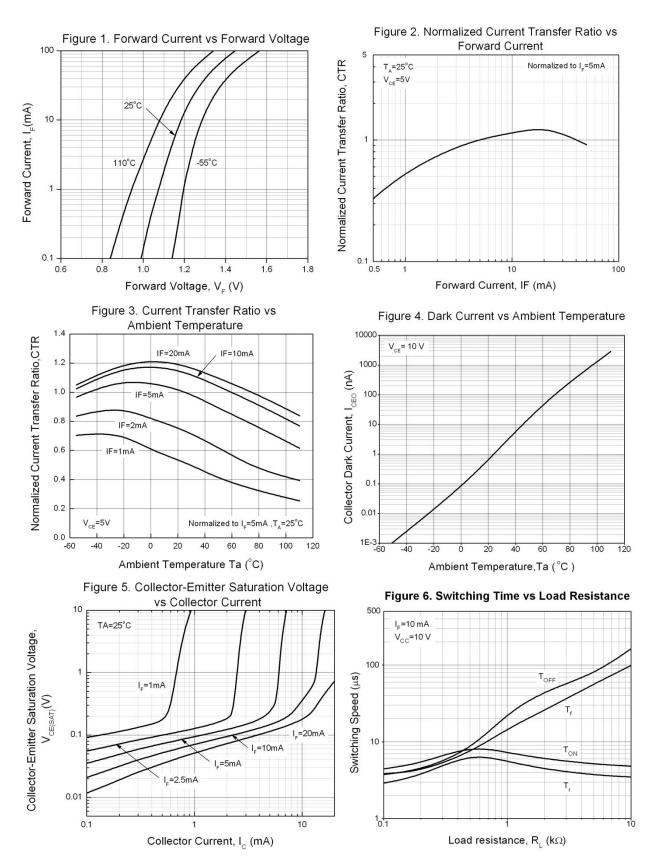
	22011	-	00		000	_			
Current Transfer	EL817A		80	-	160				
	EL817B		130	-	260		$I_{F} = 5 mA$, $V_{CE} = 5 V$		
	EL817C	CTR	200	-	400	%			
ratio	EL817D		300	-	600				
	EL817X		100	-	200				
	EL817Y		150	-	300				
Collector-Emitter saturation voltage		V _{CE(sat)}	-	0.1	0.2	V	$I_{F} = 20mA$, $I_{C} = 1mA$		
Isolation resistance		R _{IO}	5×10 ¹⁰	-	-	Ω	V _{IO} = 500Vdc, 40~60% R.H.		
Floating capacitance		C _{IO}	-	0.6	1.0	pF	$V_{IO} = 0$, f = 1MHz		
Cut-off frequency		fc	-	80	-	kHz	$V_{CE} = 5V, I_{C} = 2mA$ $R_{L} = 100\Omega, -3dB$		
Rise time		t _r	-	-	18	μs	$V_{CE} = 2V, I_{C} = 2mA,$		
Fall time		t _f	-	-	18	μs	$R_L = 100\Omega$		

* Typical values at T_a = 25°C

DATASHEET 4PIN DIP PHOTOTRANSISTOR PHOTOCOUPLER EL817 series

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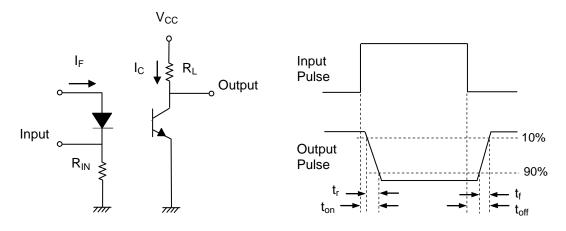


Figure 7. Switching Time Test Circuit & Waveforms

Order Information

Part Number

EL817X(Y)(Z)-FV

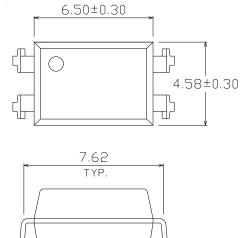
Note

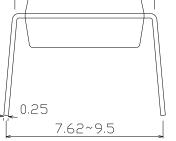
- X Y = Lead form option (S, S1, S2, M or none)
- = CTR Rank (A, B, C, D, X, Y or none)
- Ζ = Tape and reel option (TA, TB, TU, TD or none)
- = Lead frame option (F: Iron, None: copper) F
- V = VDE safety (optional).

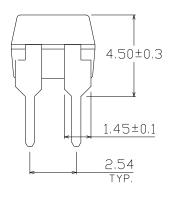
Option	Description	Packing quantity
None	Standard DIP-4	100 units per tube
М	Wide lead bend (0.4 inch spacing)	100 units per tube
S (TA)	Surface mount lead form + TA tape & reel option	1000 units per reel
S (TB)	Surface mount lead form + TB tape & reel option	1000 units per reel
S1 (TA)	Surface mount lead form (low profile) + TA tape & reel option	1000 units per reel
S1 (TB)	Surface mount lead form (low profile) + TB tape & reel option	1000 units per reel
S2 (TA)	Surface mount lead form (Gull-wing) + TA tape & reel option	1000 units per reel
S2 (TB)	Surface mount lead form (Gull-wing) + TB tape & reel option	1000 units per reel
S (TU)	Surface mount lead form + TU tape & reel option	1500 units per reel
S (TD)	Surface mount lead form + TD tape & reel option	1500 units per reel
S1 (TU)	Surface mount lead form (low profile) + TU tape & reel option	1500 units per reel
S1 (TD)	Surface mount lead form (low profile) + TD tape & reel option	1500 units per reel
S2 (TU)	Surface mount lead form (low profile) + TU tape & reel option	2000 units per reel
S2 (TD)	Surface mount lead form (low profile) + TD tape & reel option	2000 units per reel

Package Dimension (Dimensions in mm)

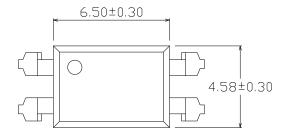
Standard DIP Type

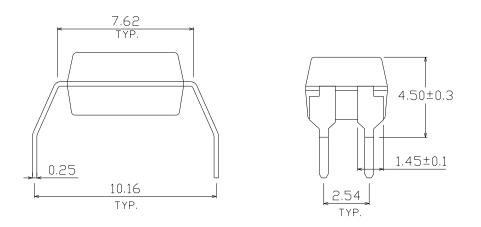






Option M Type

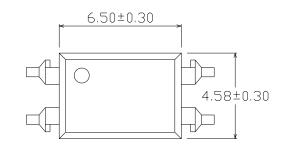


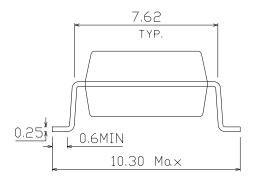


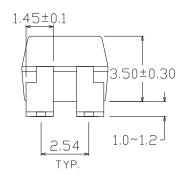
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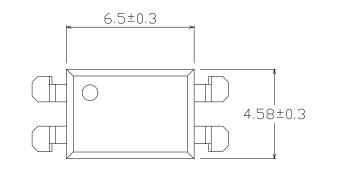
Option S Type

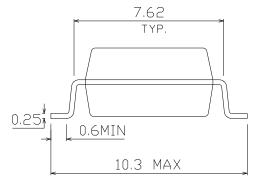


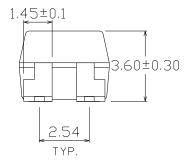




Option S1 Type

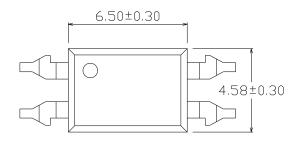


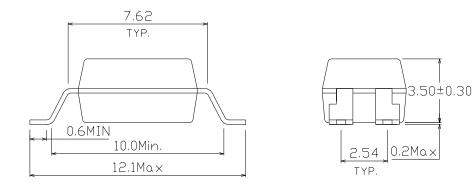




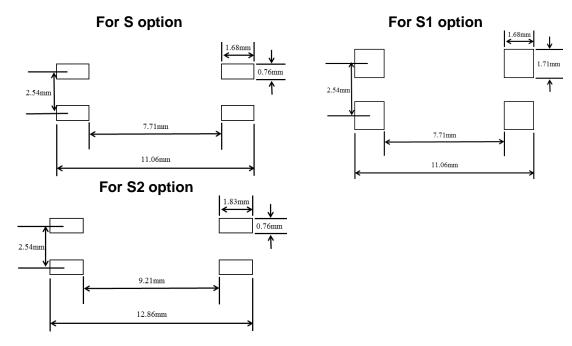
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Option S2 Type





Recommended pad layout for surface mount leadform



Notes

Suggested pad dimension is just for reference only. Please modify the pad dimension based on individual need.



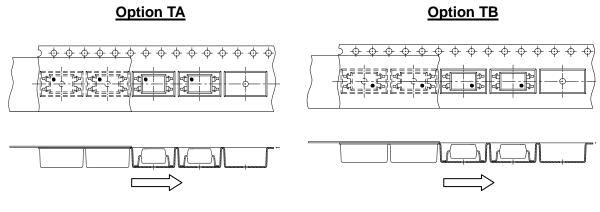
Device Marking



Notes

- 817 denotes Device Number
- F denotes Factory Code (G: China and Green part)
- R denotes CTR Rank (A, B, C, D , X , Y or none)
- Y denotes 1 digit Year code
- WW denotes 2 digit Week code
- V denotes VDE (optional)

Tape & Reel Packing Specifications

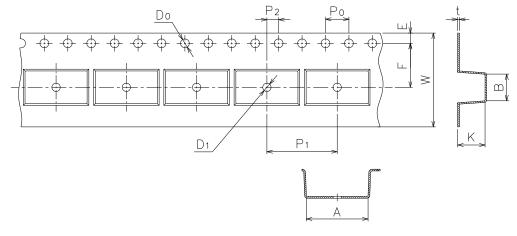


Direction of feed from reel

Direction of feed from reel

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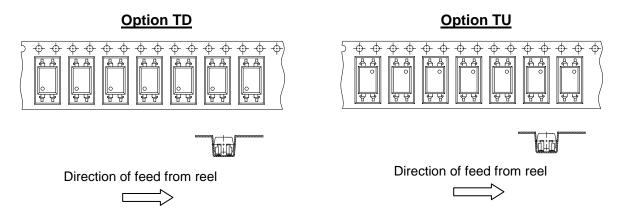
Tape dimensions



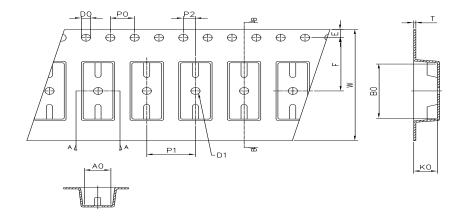
Dimension No.	Α	В	Do	D1	Е	F
Dimension (mm) S	10.7±0.1	4.65±0.1	1.5±0.1	1.50±0.1	1.75±0.1	7.5±0.1
Dimension (mm) S1	10.7±0.1	4.65±0.1	1.5±0.1	1.50±0.1	1.75±0.1	7.5±0.1
Dimension (mm) S2	12.15±0.1	4.65±0.1	1.5±0.1	1.50±0.1	1.75±0.1	7.5±0.1
Dimension No.	Ро	P1	P2	t	w	к
Dimension (mm) S	4.0±0.1	12.0±0.1	2.0±0.1	0.4±0.1	16.0±0.3	4.75±0.1
Dimension (mm) S1	4.0±0.1	12.0±0.1	2.0±0.1	0.4±0.1	16.0±0.3	3.90±0.1
Dimension (mm) S2	4.0±0.1	16.0±0.1	2.0±0.1	0.4±0.1	16.0±0.3	3.90±0.1

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Tape & Reel Packing Specifications



Tape dimensions



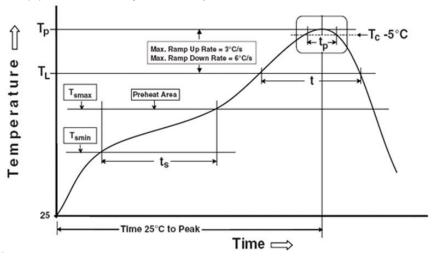
Dimension No.	Ao	Во	Do	D1	Е	F
Dimension (mm) S.S1	4.90±0.1	10.40±0.1	1.5±0.1	1.50±0.1	1.75±0.1	7.50±0.1
Dimension (mm) S2	4.88±0.1	12.55±0.1	1.5±0.1	1.50±0.1	1.75±0.1	11.5±0.1
Dimension No.	Ро	P1	P2	t	w	Ко
Dimension (mm) S.S1	4.00±0.1	8.00±0.1	2.00±0.1	0.40±0.1	16.00±0.3	4.60±0.1



Precautions for Use

1. Soldering Condition

1.1 (A) Maximum Body Case Temperature Profile for evaluation of Reflow Profile



Note:

Preheat

Temperature min (T _{smin})	150 °C
Temperature max (T _{smax})	200°C
Time (Tsmin to Tsmax) (ts)	60-120 seconds
Average ramp-up rate (Tsmax to Tp)	3 °C/second max

Other

Liquidus Temperature (T _L)	217 °C
Time above Liquidus Temperature (t $_{L}$)	60-100
Peak Temperature (T _P)	260°C
Time within 5 °C of Actual Peak Temperature: T_P - 5°C	30 s
Ramp- Down Rate from Peak Temperature	6°C /se
Time 25°C to peak temperature	8 minut
Reflow times	3 times

Reference: IPC/JEDEC J-STD-020D

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